

RA4W1 Group

Testing for Certification of Compliance with the Radio Law (Japan)

Introduction

This application note describes testing for certification of compliance with the Radio Law in Japan.

Target Device

RA4W1 Group

Note: Descriptions in this application note are examples for reference and actual procedures will differ with the system configuration and certification body. In addition, confirm the latest information on test standards and so on. This application note is created on the basis of available information as of October in 2019.

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1. Overview

This application note describes how to prepare an application for obtaining certification of compliance with the Radio Law in Japan and the operations involved in testing.

1.1 Related Documents

Please refer to the following documents related to this application note.

- RA4W1 Group User's Manual: Hardware (R01UH0883)
- Bluetooth Low Energy MCU Bluetooth Test Tool Suite operating instructions (R01AN4554)



2. Preparing an Application

To make an application, carry out a preparatory examination and draw up the application forms.

2.1 The Preparatory Examination

Examine the frequency variation in continuous non-modulated transmission. Also examine the occupied bandwidths with and without spectrum spreading, the intensity of spurious or unwanted emissions, the variation of antenna power in the continuous transmission of a pseudo-random bit sequence, and the intensity of radio fields such as secondarily generated radio waves in reception. After that, confirm that the device is in conformity with the ARIB STD-T66 standard.

For a testing method, refer to TELEC-T401, a characteristics testing method for radio equipment for use in radio systems for low-power data communications using radio waves with frequency in the range from 2,400 MHz to 2,483.5 MHz (2.4-GHz-band advanced low-power data communications systems).

Items to be confirmed are listed below. All samples are tested around three frequencies: 2,402, 2,440, and 2,480 MHz on each LE 1M PHY and LE 2M PHY. For the operations involved in testing, refer to "3. Operations Involved in Testing".

Declared antenna power: x.xx mW Sample 1 (MHz) Judge Item Unit Lower Upper 2402 2440 2480 Frequency MHz Carrier

Table 2-1. The preparatory examination confirmation items

Remarks Frequency Difference -50.00 50.00 ppm Lower MHz Occupied Upper MHz Bandwidth Bandwidth MHz 26.00 Antenna power mW Difference from declared Carrier Power power of the antenna Difference % -80.0 20.0 Unwanted Emission MHz (2374 to 2509.5 MHz uW/MHz 2.50 (except for 2387 to 2496.5 MHz)) **Unwanted Emission** MHz (2387 to 2496.5 MHz uW/MHz 25.00 (except for 2400 to 2483.5 MHz)) Unwanted Emission MHz (30 to 2374 MHz) uW/MHz 2.50 MHz **Unwanted Emission** (2509.5 to 12500 MHz) uW/MHz 2.50 MHz Radiation (30 to 1000 MHz) nW 4.00 MHz Radiation (1000 to 12500 MHz) nW 20.00



OBW: 1.5 MHz

2.2 Drawing up the Application Forms

Draw up the application forms listed below. Use the forms prescribed by the respective certification bodies.

- Application form for test certification
- Type specifications
- Block diagram of radio equipment
- Photographs or drawings showing the component layout
- Dimensions and outline drawing of shape showing that it cannot be opened easily

2.2.1 Application form for test certification

Obtain the Application form for test certification from the certification body. A description example is shown below.

Table 2-2. A description example of application form for test certification

o: Telecom Engi	neering Center		Date of	application:
	(Applicant's)		on name: ntative, position: ble person, division:	
adio Act, in acco	(Proxy's) certification of equipment w	Zip code: Address: Corporat Person's (Seal or ith the attac	ion name: name, position: signature) hed construction type,	ure to the following proxy. (*1) under the provisions of Article 38-6 of Regulations Conformity Certification
ype Certification			New (🖌)	Simplified ()
Category of spe	cified radio equipment		Radio equipment uno Paragraph(1) Ordinance	ler Article 2 Item(19) of Certification
Type or name of	radio equipment		xxxxxxxxx	
	radio equipment ent manufacturer		xxxxxxxxxx xxxxxxxxxxxxx	ζ
Name of equipm				ζ
Name of equipm Serial number	ent manufacturer		xxxxxxxxxxxxxxx	(
Name of equipm Serial number Number of units Emission modes	ent manufacturer	power to be	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 180 MHz (2 MHz interval 40 waves)
Name of equipm Serial number Number of units Emission modes certified	ent manufacturer	power to be	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 180 MHz (2 MHz interval 40 waves)
Name of equipm Serial number Number of units Emission modes certified Connection to te	ent manufacturer applied , frequencies and antenna p lecommunication link	power to be	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 180 MHz (2 MHz interval 40 waves) XXW (*A)
Name of equipm Serial number Number of units Emission modes certified Connection to te Submission of ra	ent manufacturer applied , frequencies and antenna p lecommunication link	power to be	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 480 MHz (2 MHz interval 40 waves) XXW (*A) No(✔)
Name of equipm Serial number Number of units Emission modes certified Connection to te Submission of ra Submission of cl Article 14-2 Para	ent manufacturer applied , frequencies and antenna p lecommunication link idio equipment naracteristic test report		XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 480 MHz (2 MHz interval 40 waves) (XXW (*A) No (✔) No ()
Name of equipm Serial number Number of units Emission modes certified Connection to te Submission of ra Submission of cl	ent manufacturer applied , frequencies and antenna p lecommunication link idio equipment naracteristic test report	egulating	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	1D 480 MHz (2 MHz interval 40 waves) XXW (*A) No (✔) No (✔)



RA4W1 Group Testing for Certification of Compliance with the Radio Law (Japan)

	Difference from certified Radio equipment	(Attached sheet)
	Zip code, address	
	Division name	
Contact address	Name of person	
	Telephone number	
	e-mail or facsimile	
Remarks		

Notes:

Filling in the blanks marked by (*1) is not required in case of no proxy.
 Filling in the blanks marked by (*2) is not required in case of new application.

Notes: A. Please apply for an antenna power allowable deviation within the range of + 20% to -80%.



2.2.2 Type specifications

Please obtain the type specifications from the certification body. The form is "No. 3", and the target radio equipment is "Type Specifications of radio equipment used for citizen's band radio stations, cordless telephone radio stations, specified low-power radio stations, radio stations for low-power security systems, radio stations for low-power data communications systems, digital cordless telephone radio stations, PHS land mobile stations, narrow-area communications system land mobile stations, and land mobile stations of 5 GHz band wireless access system, land mobile stations of a narrow-area communications system". A description example of the type specifications document is shown below.

Table 2-3. A description example of type specifications

Type Specifications

1 Communicat	ion Method	Simplex					
	(1) Rated Output	0.00XXX W (*1)	(2) Type and Frequency R Transmittabl Wave	ange of	F1D 2402 to 2480 MHz (2- MHz intervals, 40 waves)		
2 Transmitter	(3) Oscillation	Synthesizer method with frequency of oscillation controlled by a crystal resonator Reference frequency: 32 MHz					
	(4) Modulation	F1D GFSK 1Mbps, 2M	lbps				
3 Manufacturer Information		Name of Manufacturer	Model Type or Name		Serial Number		
		xxxxxxx	xxxxxxx		xxxxxxx		
		(1) Type and Structure		(2) Gain			
4 Antenna		λ/4-type Monopole type (H) Chip antenna (*2) +2.3		+2.3 dBi (IBi (*2)		
5 Classificatior Name of Auxili	n and Model Type or ary Equipment	The function specified in Article 9-4-8 of the Radio Equipment Regulations Controller: PC with USB I / F (Connect using USB cable) (*3)					
6 Other Type S	Specifications Items	Conformance with technical standards stipulated in Chapter 3 of the Radio Law No connection with public lines Specific radio equipment of the module type					
7 Attached Dra	awing	Block diagram of radio equipment					
8 Reference In	formation	Model Type or Name of Radio Equipment: XXXXXXX Antenna impedance: 50Ω Rated power supply voltage: DC5.0V The main part of the modulation part and the radio part is mounted on an integrated circuit in a QFN (56) package with a pin spacing of 0.4 mm, and is soldered to the board by surface mounting technology, so that it cannot be opened easily. (*4)					

Notes: 1. In making an application, report a value such that any change from that given will be within the range from +20% to -80%.

- 2. Write the format, configuration, and gain that match the data sheet characteristics.
- 3. Describe the methods of operation in the examinations.
- 4. Describe the explanation that "High-frequency part and modulation part cannot be opened easily".



2.2.3 Block diagram of radio equipment

The following is an example. Create it accord with the actual system.

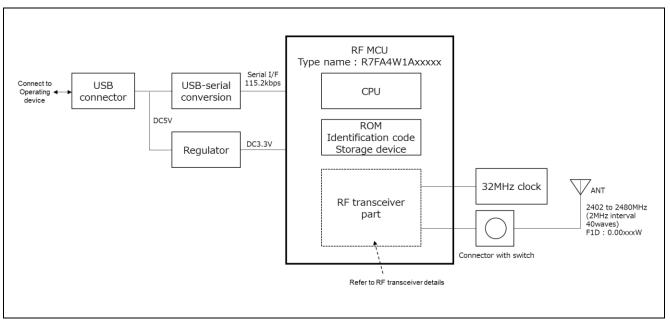


Figure 2-1. Block diagram of radio equipment (Example)

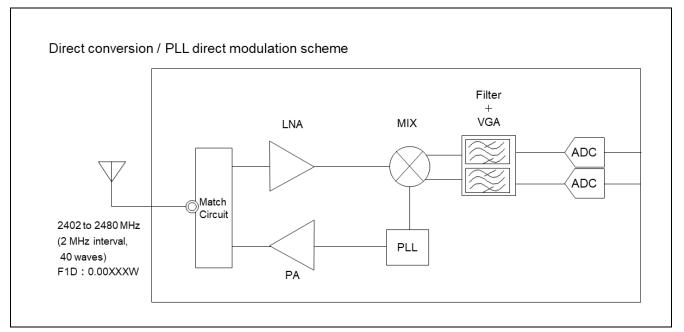


Figure 2-2. Block diagram of radio equipment — RF transceiver details (Example)



2.2.4 Photographs or drawings showing the component layout

The following is an example. Create it accord with the actual system.

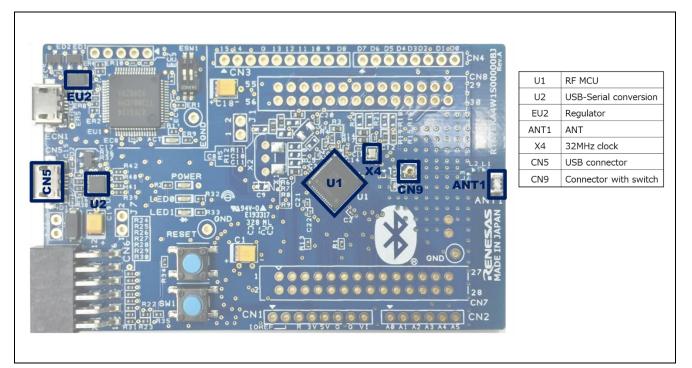


Figure 2-3. Photographs or drawings showing the component layout (Example)



2.2.5 Dimensions and outline drawing of shape showing that it cannot be opened easily

This is an example of drawing showing outlines the structure and shape of the radio equipment regarding "the high-frequency part and modulation part cannot be opened easily". Create it accord with the actual system.

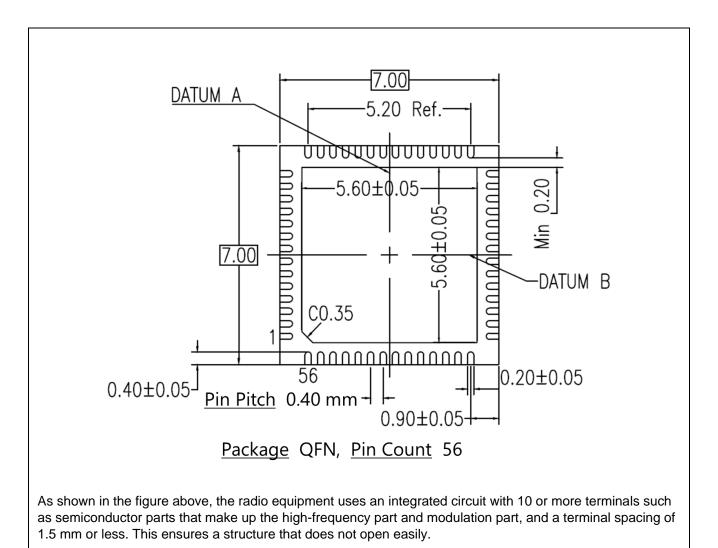


Figure 2-4. Dimensions and outline drawing of shape (Example)



2.2.6 Other documents

If the certification body requests the submission of the following documents, prepare according to the instructions of the certification body.

2.2.6.1 Document about antenna

Prepare the data (data sheet) that provides the basis for gain, such as shape, dimensions, and measurement results.

2.2.6.2 Correspondence table of manufacturing numbers and identification codes

Create a correspondence table between the manufacturing number and identification code of the application product. A description example is shown below.

Table 2-4. Correspondence table of manufacturing numbers and identification codes (Example)

Manufactur	ing numbers	Identification codes
ABC	0021	xx-xx-xx-xx- A0
ABC	0022	xx-xx-xx-xx- A1
ABC	0023	xx-xx-xx-xx- A2
ABC	0024	xx-xx-xx-xx- A3
ABC	0025	xx-xx-xx-xx- A4
ABC	0026	xx-xx-xx-xx- A5
ABC	0027	xx-xx-xx-xx- A6
ABC	0028	xx-xx-xx-xx- A7
ABC	0029	xx-xx-xx-xx- A8
ABC	0030	xx-xx-xx-xx- A9
ABC	0031	xx-xx-xx-xx- AA
ABC	0032	xx-xx-xx-xx- AB
ABC	0033	xx-xx-xx-xx- AC
ABC	0034	xx-xx-xx-xx- AD
ABC	0035	xx-xx-xx-xx- AE
ABC	0036	xx-xx-xx-xx- AF
ABC	0037	xx-xx-xx-xx- B0
ABC	0038	xx-xx-xx-xx- B1
ABC	0039	xx-xx-xx-xx- B2
ABC	0040	xx-xx-xx-xx- B3
ABC	0041	xx-xx-xx-xx- B4
ABC	0042	xx-xx-xx-xx- B5
ABC	0043	xx-xx-xx-xx- B6
ABC	0044	xx-xx-xx-xx- B7
ABC	0045	xx-xx-xx-xx- B8

2.2.6.3 Photograph or figure showing appearance

Prepare an appearance diagram that shows the dimensions and elsewhere of the application product.



3. Operations Involved in Testing

Use the SMA connector to connect the device under test to the measuring instrument of the certification body. Make sure that the SMA connector can be connected from the end of the antenna.

Table 3-1 describes the test items, the execution operations of the device under test (hereinafter DUT), and the Bluetooth Test Tool Suite (hereinafter BTTS) tools to use.

Table 3-1.	The test items.	the execution o	perations of the I	DUT, and the B	TTS tools to use
			perations of the l		

Test item	Execution operation	BTTS tool
Frequency variation	3.1 CW (non-modulated continuous wave) Transmission	RF Evaluation tool
Occupied bandwidth with and without spectrum spreading	3.2 Continuous Transmission of a Pseudo-Random Bit Sequence	RF Evaluation tool Re
Intensity of spurious or unwanted emission	3.2 Continuous Transmission of a Pseudo-Random Bit Sequence	RF Evaluation tool Re
Variation of antenna power	3.2 Continuous Transmission of a Pseudo-Random Bit Sequence	RF Evaluation tool Re
Intensity of radio fields such as secondarily generated radio waves	3.3 Reception	RF Evaluation tool Re
Functions for preventing interference (between identifying codes)	3.4 Scanning (*1)	Beacon tool Ba Bs

*1 : Confirming the BD address of the opposite device (Opposing device performs advertising)

Notes: When using the BTTS in certification tests, refer to the following contents in the "Bluetooth Low Energy MCU Bluetooth Test Tool Suite operating instructions (R01AN4554)" (hereinafter, "Operating instructions").

- Overview Describes the features and operating environment of BTTS.
 Installation
- Describes the contents and installation procedure of the BTTS package.
- Common operation
 Describes how to start the tool and how to connect to the target device.
- 6.2.3 Filter settings

Describes how to set the filter to make it easier to detect the target device.



3.1 CW (non-modulated continuous wave) Transmission

- 1. Select "RF Evaluation" in the tool launcher to start the RF evaluation tool. Connect the DUT according to the procedure described in the Operating instructions.
- 2. Click the "Transmit Test" of the upper part tab and select the "Continuous Wave Transmit" radio button.
- 3. Select the non-modulated wave "Modulation Disable" with the pull-down menu below the radio button.
- 4. Select "Middle" as the transmission power with the "Transmit Power" pull-down menu.
- 5. Select "1M" or "2M" as the transmission PHY with the "PHY" pull-down menu.
- 6. Select the transmission frequency channel with the "Transmit Frequency" pull-down menu. Low: 2402MHz (RF-Ch.00), Middle: 2440MHz (RF-Ch.19), High: 2480MHz (RF-Ch.39)
- 7. Click the ">START" button to start CW transmission.
- 8. Click the **STOP** button to stop transmission.

To change the PHY, perform steps 5 through 8. To change the frequency, perform steps 6 through 8.

🐏 Bluetooth Test Tool Suite (BTTS) No.1 COM9 : 749050-00955B	– 🗆 ×
file View Help	
1 COM9 : USB Serial Port (COM9) ✓ 2000000 bps Close	
Transmit Test Receive Test	
START STOP	RENESAS
Transmit Frequency 2440MHz (RF-Ch.19, Ch.Index17) * PHY 1M	
Transmit Power Middle (0 dBm) *	
Continuous Wave Transmit Modulation Disable	
Modulation Disable *	
Packet Data Type 0x00 : PRBS9	
Packet Data Type 0x00: PRBS9 Trasnsmit Payload Length 37 < (0 ~ 255 bytes)	
Packet Data Type 0x00 : PRBS9	
Packet Data Type0x00 : PRBS9Trasnsmit Payload Length37 < (0 ~ 255 bytes)	
Trasnsmit Payload Length 37 · (0 ~ 255 bytes)	
Packet Data Type0x00 : PRBS9Trasnsmit Payload Length37 < (0 ~ 255 bytes)	
Packet Data Type 0x00: PRBS9 Trasnsmit Payload Length 37 < (0 ~ 255 bytes)	
Packet Data Type0x00 : PRBS9Trasnsmit Payload Length37 < (0 ~ 255 bytes)	
Packet Data Type0x00 : PRBS9Trasnsmit Payload Length37 < (0 ~ 255 bytes)	
Packet Data Type 0x00 : PRBS9 Trasnsmit Payload Length 37 < (0 ~ 255 bytes)	
Packet Data Type 0x00 : PRBS9 Trasnsmit Payload Length 37 < (0 ~ 255 bytes)	

Figure 3-1. CW transmission settings



3.2 Continuous Transmission of a Pseudo-Random Bit Sequence

- 1. Select "RF Evaluation" in the tool launcher to start the RF evaluation tool. Connect the DUT according to the procedure described in the Operating instructions.
- 2. Click the "Transmit Test" of the upper part tab and select the "DTM Transmit" radio button.
- 3. Select the pseudo-random number "0x00: PRBS9" (pseudo-random bit sequence with period 2⁹-1) with the pull-down menu below the radio button.
 - Select "0" (Infinity) with the "Number of Transmit Packets" pull-down menu.
- 4. Select "Middle" as the transmission power with the "Transmit Power" pull-down menu. Select "Low" or "High" when performing the "Antenna Power Deviation" test.
- 5. Select "1M" or "2M" as the transmission PHY with the "PHY" pull-down menu.
- 6. Select the transmission frequency channel with the "Transmit Frequency" pull-down menu.
- Low: 2402MHz (RF-Ch.00), Middle: 2440MHz (RF-Ch.19), High: 2480MHz (RF-Ch.39)
- 7. Click the ">START" button to start continuous transmission of pseudo-random numbers.
- Click the "STOP" button to stop continuous transmission.
 To change the PHY, perform steps 5 through 8. To change the frequency, perform steps 6 through 8.

1 COM9 : USB Serial Port (COM9) ∨ 2000000 bps Close	
Transmit Test Receive Test	
START STOP	RENESAS
Transmit Frequency 2440MHz (RF-Ch.19, Ch.Index17) Y PHY 1M Y	
Transmit Power Middle (0 dBm) *	
Manshiel ower made to domy	
- O Continuous Wave Transmit —	
Modulation Disable	
• • DTM Transmit	
Packet Data Type 0x00 : PRBS9 *	
Trasnsmit Payload Length 37 v (0 ~ 255 bytes)	
Trasnsmit Payload Length37 v(0 ~ 255 bytes)Number of Transmit Packets0 v(1 ~ 65535 Count or 0:Infinity)	

Figure 3-2. Pseudo random number continuous transmission setting



3.3 Reception

- 1. Select "RF Evaluation" in the tool launcher to start the RF evaluation tool. Connect the DUT according to the procedure described in the Operating instructions.
- 2. Click the "Receive Test".
- 3. Select "0" (Infinity) with the "Expected Packet Counts" pull-down menu.
- 4. Select "1M" or "2M" as the receive PHY with the "PHY" pull-down menu.
- 5. Select the receive frequency channel with the "Receive Frequency" pull-down menu. Low: 2402MHz (RF-Ch.00), Middle: 2440MHz (RF-Ch.19), High: 2480MHz (RF-Ch.39)
- 6. Click the ">START" button to start receiving operation.
- Click the "STOP" button to stop receiving operation.
 To change the PHY, perform steps 4 through 7. To change the frequency, perform steps 5 through 7.

Transr		Port (COM9)		2000000	bps	Close						
	nit Test Receive T	est									RE	NESAS
	ART STOP											
Rec	eive Frequency 2	440MHz (RF-0	Ch.19,	Ch.Index17)	~	PF	HY	1M	~			
	-		_					_				
Expect	ed Packet Counts	0	~ (1 ~	65535 Count	t or 0:Inf	inity) Pl	ER[%]		-			
						DCC	C 10 1					
OK Pac CRC Er							max.[dBm] ave.[dBm]					
							min.[dBm]					
Mem								_				Class
wem				Expected			CRC					Clear
		Channel	PHY	Packets	PER	OK Packets	Error	RSSI max.	RSSI ave.	RSSI min.	Memo	
No.	Time						Packets					
No.	Time			Counts								
No.	Time			councs								
No.	Time			Councs								
No.	Time			Counts								
No.	Time			Counts								
No.	Time			Counts								

Figure 3-3. Receive operation setting



3.4 Scanning

3.4.1 Execute Advertising

To perform scanning on the receiving device side, first execute advertising on the opposite device side.

- 1. Select "Beacon Advertising" in the tool launcher to start the beacon advertising tool. Connect the DUT according to the procedure described in the Operating instructions.
- 2. Check the checkbox on the "Handle #0" tab at the top.
- 3. Check the "Public" radio button in the "Advertising Address" frame.
- 4. Enter "0000A0" in the "Advertising Interval" text box and set the advertising interval to 100 msec. (Can be changed to any interval)
- 5. Check the "Legacy" radio button in the "Data Packet Length" frame.
- 6. Check the checkbox for all channels in "Advertising Channel".
- 7. Select "Local Name" from the "Advertising Data" pull-down menu, and enter an arbitrary device name in the text box.
- 8. Click the ">START" button to start advertising.
- 9. After the test is complete, click the "**STOP**" button to stop advertising.

1 COM4 : USB Serial Port (COM4) V 2000000 bps Close	
START STOP Transmit Power : Middle (0 dBm) >	
Handle #0 Handle #1 Handle #2 Handle #3	2 ENICE AS
Advertising Address Public Random 000000 - 000000	
Advertising Interval (0x000020-0xFFFFF) 0000F2 x 0.625 = 151.2	250 ms
Data Packet Length	
Advertising Channel 🗹 37 🗹 38 🗹 39	
Advertising Data	
Local Name V RA4W1_QFN_SMD_EvaB #00	
Scan Response Data	
URI v https://bit.ly/3cMhQ3T	

Figure 3-4. Advertising setting (opposite device side)



3.4.2 Execute Scanning

The receiving device side performs scanning.

- 1. Select "Beacon Scanning" in the tool launcher to start the beacon scanning tool. Connect the DUT according to the procedure described in the Operating instructions.
- 2. Check the "Passive" radio button in the "Scanning Mode" frame.
- 3. Check the "Normal Range (1M PHY)" check button.
- 4. Enter "0640" in the "Interval" text box and "0640" in the "Window" text box to set the scanning duty cycle to 100%. (Can be changed to any value)
- 5. Depending on the environment of the surrounding advertiser, enable the filter function according to the procedure described in the Operating instructions.
- 6. Click the ">START" button to start scanning.
- 7. Confirm that the information of the opposite device is displayed in the "Scanning Result:" data grid.
- 8. After the test is complete, click the **"S**TOP" button to stop scanning.

START	TOP						RE	NESAS
Scanning	Mode :		• Passive	O Active	•			
✓ Normal	Range (1	IM PHY)		x0004-0xFFFF) :		_	1000.000 ms	
Long R	ange (Coo	ded PHY)	Interval (0:	0x0004-0xFFFF) : x0004-0xFFFF) : 0x0004-0xFFFF) :	0640	x 0.625 =	1000.000 ms 1000.000 ms 250.000 ms	
Filter :	Non-	Connectal	le Advertising	RSSI (dB	m) -60	Ad	dress 749050 - 000000	
Scanning F	Result :							
Device A 749050-0		PHY 1M	Addr Type Public	Device Name RA4W1_QFN_S	MD_EvaB #00	RSSI -53	Latest Reception Time 19/11/15 14:59:12:047	

Figure 3-5. Scanning setting (receiving device side)



Revision History

		Description	
Rev.	Date	Page	Summary
1.00	May.07.20	—	First edition issued



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

Notice

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
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(Rev.4.0-1 November 2017)

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